

U.S. Member Body of the International Organization for Standardization (ISO)



**HEAD OF DELEGATION** 

U.S. National Committee of the International Electrotechnical Commission (IEC)

Please return this report within one month of the completion of the international meeting and submit it to the appropriate ANSI Department as follows:

ISO

**USNC** 

ISOT@ansi.org

USNC@ansi.org

HoD reports can be used for a variety of purposes. For example:

- **\*** To report results of a TC/SC meeting to the related TAG
- To publicize the work of the TC/SC to the related US constituency via ANSI On-line, USNC News and Notes, or other media
- \* To suggest areas for possible development of featured articles
- To address specific challenges and concerns that the HoD may bring to the attention of related ANSI and/or USNC/IEC management

PLEASE REMEMBER: Your HoD report is NOT filed as a confidential, password protected document and, therefore, may have broad, unintended distribution. Keep this in mind when preparing the report and, if appropriate, use a more secure form of correspondence to call attention to any sensitive issues.

**Completed by:** 

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Date:	1/24/2015

## Meeting of (Designation/Title) SC 23E / Circuit-Breakers and Similar Equipment for Household Use Date(s) 11/18/2014 Location Mexico City, Mexico

Please indicate, if available, both the number of delegates and the countries represented at the Meeting:

There were 35 delegates from 17 countries as follows; BE, CA, CH, CN, CR, DE, DK, CH ES, FR, IT, KR, MX, NO, SE, UK, US AND ZA

**<u>X</u>** Meeting attendance roster and meeting resolutions attached, if available

Please comment on significant or unusual attendance issues (e.g., new member bodies, regular members not in attendance, new Chairman or Secretariat, non-accredited U.S. persons, etc.).

The meeting was chaired by Mr. Claus Dieter Ziebell in replace of the Chairman Mr. Kruger who was ill and unable to attend.

	MEETING OBSERVATIONS
2.	Overall, how well did the U.S. meet its objectives on policy or technical matters?
	Very Successful U.S. positions were accepted in whole     X   Successful Compromises were reached which are acceptable to the U.S.     Not Successful U.S. positions were not accepted
3.	Please comment on any issues of significance which might have an impact upon materially affected or interested U.S. parties.
	All committee reports were presented without issues.
	Notes of interest;
	(1) The committee approved all conveners of working groups for another 3 years.
	(2) The committee approved starting a new program of work for Circuit Breakers for DC applications. This would be of interest for manufacturers of related products.
	(3) The committee approved starting a new program of work for RCDs for DC applications. This would be of interest for manufacturers of related products.
	(4) There was a discussion and formation of a working group to address GSP for RCDs.
4.	Was there any discussion for which the United States was unprepared? (e.g., late document distribution, addition of new items, etc.)
	None

5.	Did the U.S. extend an offer to assume any new TC/SC Secretariat or management positions?
	Yes $\underline{X}$ No(If yes, please indicate which position and provide Officer contact information.)
6.	Did the U.S. extend an offer to host any future TC/SC meetings?
	Yes <u>X</u> No If yes, please identify:
7.	Were any new issues raised which require, or might involve, coordination with other U.S. bodies? (Include coordination items with other U.S. TAGs, ANSI policy-level committees (AIF, AIC, the USNC TMC and/or Council, etc.)
	Yes <u>X</u> No If yes, please identify:
8.	Did the U.S. put forth/agree to put forth any New Work Items?
	Yes $\underline{X}$ NoIf yes, please identify:
9.	Was there any evidence of irregular voting by participating countries?
	Yes $\underline{X}$ NoIf yes, please identify any significant issues or concerns:
10.	Are work items in the TC or SC being affected by related work in regional standards bodies (e.g., CEN, CENELEC, ETSI, PASC, NAFTA, COPANT, etc.)?
	Yes X No   No related regional activity If yes, please explain:
11.	Were any new issues raised which require, or might involve, coordination with emerging market countries?
	Yes <u>X</u> No If yes, please explain:
12.	Were any issues raised which relate to or impact existing U.S. regulatory matters?
	Yes <u>X</u> No If yes, please explain:

13.	Please identify any IMMEDIATE U.S. TAG actions which will be required as a result of this international meeting.
	The TAG for 23 E should closely follow the two working groups formed for DC applications of circuit breakers.
14.	Please identify specific decisions which the U.S. delegation believes to be noteworthy for publication, publicity and/or development of a future article. If there are any, would you be willing to help develop an article for publication?
	Yes <u>X</u> No
15.	What might be done to further promote the ANSI Federation's goal of "global standards that reflect U.S. interests?" (Consider such issues as how might the U.S. further promote acceptance of related American National Standards in international and, where applicable, regional fora?)
	The formation of the working groups for the development of DC Circuit breakers and RCDs present an opportunity for manufacturers of these types of products to participate in the development of these new product standards.
16.	Has this report been provided to your TAG Administrator for US TAG distribution?
	<u>X</u> Yes No
17.	Other Comments

September 2012